



**Intel® Server Board S2600KP Product Family**  
**Intel® Compute Module HNS2600KP Product Family**

***Monthly Specification Update***

**June 2017**

Intel® Server Products and Solutions

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## **Document Revision History**

<b>Date</b>	<b>Changes</b>
September 2016	MSU program re-introduced Standard format introduced Added new Product Codes and updated FW stack EPSD case number introduced
October 2016	Corrected Product Code for boards by removing the "BB" prefix Added more Product Codes and updated FW stack Typographical corrections
November 2016	Added more Product Codes and updated FW stack Font type and source standardized.
December 2016	Added S2600KPTR board and updated its FW stack
January 2017	Added more Product Codes and updated FW stack
February 2017	No update
March 2017	No update
April 2017	No update
May 2017	Added more Product Codes and updated FW stack
June 2017	Corrected March 2017 Document Revision History to "No update"

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# 1. Preface

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This document is intended to communicate product errata, published specification changes, published specification clarifications, and published document changes for the following Intel server products:

- Intel® Server Board S2600KP product family
- Intel® Compute Module HNS2600KP product family

It is intended for system integrators and software developers of applications, operating systems, or tools.

## 1.1 Nomenclature

1. **Specification Changes** are modifications to the current published specifications for Intel server boards.
2. **Specification Clarifications** describe a specification in greater detail or further highlight a specification's impact to a complex design situation.
3. **Documentation Changes** include typos, errors, or omissions from the current published specifications.
4. **Errata** are design defects or errors. Errata may cause the server board or system behavior to deviate from published specifications. Hardware and software designed to be used with any given processor stepping must assume that all errata documented for that processor stepping are present on all devices.

## 2. Product Scope

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The following specific boards, BIOS, and components are covered by this update:

Product Code	Baseboard PBA Revision	BIOS Revision	ME Revision	BMC Revision	FRU/SDR Revision
S2600KPR	H13888-361 / 371 / 372	01.01.0016	03.01.03.021	01.43.9685	1.14
S2600KPFR	G93685-361 / 371	01.01.0016	03.01.03.021	01.43.9685	1.14
S2600KPTR	H76962-362 / 371	01.01.0016	03.01.03.021	01.43.9685	1.14
S2600KPR	H13888-361 / 371 / 372	01.01.0018	03.01.03.032	01.46.9995	1.14
S2600KPFR	G93685-361 / 371	01.01.0018	03.01.03.032	01.46.9995	1.14
S2600KPTR	H76962-362 / 371	01.01.0018	03.01.03.032	01.46.9995	1.14
S2600KPR	H13888-361 / 371 / 372	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPFR	G93685-361 / 371	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPTR	H76962-362 / 371	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPR	H13888-361 / 371 / 372	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPFR	G93685-361 / 371	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPTR	H76962-362 / 371	01.01.0019	03.01.03.032	01.47.10181	1.14
S2600KPR	H13888-361 / 371 / 372	01.01.0020	03.01.03.043	01.48.10351	1.14
S2600KPFR	G93685-361 / 371	01.01.0020	03.01.03.043	01.48.10351	1.14
S2600KPTR	H76962-362 / 371	01.01.0020	03.01.03.043	01.48.10351	1.14
S2600KPR	H13888-361 / 371 / 372	01.01.0021	03.01.03.043	01.49.10574	1.16
S2600KPFR	G93685-361 / 371	01.01.0021	03.01.03.043	01.49.10574	1.16
S2600KPTR	H76962-362 / 371	01.01.0021	03.01.03.043	01.49.10574	1.16

### 3. Summary Tables of Changes

The following tables provide an overview of known errata and known document changes that apply to the specified Intel server products. The tables use the following notations:

**Doc:** Intel intends to update the appropriate documentation in a future revision.

**Fix:** Intel intends to fix this erratum in the future.

**Fixed:** This erratum has been previously fixed.

**No Fix:** There are no plans to fix this erratum.

**Shaded:** This information is either new or has been modified from the previous specification update.

**Table 1. Errata Summary**

No.	Plans	Description of Errata
1.	Workaround	SMART NVDIMM connector interferes the air duct pressing the supercap cable.

**Table 2. Documentation Changes**

No.	Document Name	Description of Documentation Change
1.	<i>Spares/Accessories List and Configuration Guide v2.25</i> <i>Service Guide v2.1</i> <i>Technical Product Specification v1.35</i>	Updated collaterals. Please refer to each collateral for details.
2.	<i>Spares/Accessories List and Configuration Guide v2.26</i> <i>Technical Product Specification v1.36</i>	Updated collaterals. Please refer to each collateral for details.
3.	<i>Spares/Accessories List and Configuration Guide v2.27</i>	Updated collateral. Please refer to each collateral for details.
4.	<i>HNS2600KP H2000G Power Budget Tool v1.5</i>	Power calculation formula on "Compute Module 1" has been updated
5.	<i>Technical Product Specification v1.37</i>	Updated collaterals. Please refer to each collateral for details.

**Table 3. Specification Changes**

No.	Specification	Description of Specification Change
1.	<i>Microsoft* Windows* Server 2016 added to the compatible list of Operating Systems</i>	The Intel® Server Board S2600KP Product Family has passed the certification for Microsoft* Windows* Server 2016.
2.	<i>System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Version R0018</i>	BIOS, ME, and BMC firmware have been updated.
3.	<i>System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Version R0019</i>	BIOS, ME, and BMC firmware have been updated.
4.	<i>System Update Package (SUP) and System Firmware Update Package (SFUP) has been released. Version R0020</i>	BIOS, ME, and BMC firmware have been updated.
5.	<i>System Update Package (SUP) and System Firmware Update Package (SFUP) has been released. Version R0021</i>	BIOS, ME, and BMC firmware have been updated.



The following sections provide in-depth descriptions of each erratum / documentation change indicated in the tables above. The errata and documentation change numbers referenced in the following sections correspond to the numbers in the tables above.

## 4. Product Errata

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**1. ID Number      EPSD100033181**  
**SMART NVDIMM connector interferes the air duct pressing the supercap cable.**

**Problem**      SMART NVDIMMs (SH1027NR410451SD2 and SH2047NR420451SB2) connector interferes with the air duct of the HNS2600KP Compute Module Product Families; pressing the SMART supercap SSC36041INT0011B cable when used on DIMM slots A1 or E1 only.

**Implication**    Cable damage and inappropriate air duct closing.

**Status**        This issue was found with these specific models (form factor and vendor only).

**Workaround**    Use DIMM slots B1 or F1 instead.

## 5. Documentation Changes

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**1. The following collaterals have been updated to revision #:**

- a. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Configuration Guide to v2.25*
- b. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Service Guide to v2.1*
- c. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Technical Product Specification to v1.35*

Please refer to each collateral for details.

**2. The following collaterals have been updated to revision #:**

- a. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Configuration Guide to v2.26*
- b. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Technical Product Specification to v1.36*

Please refer to each collateral for details.

**3. The following collaterals have been updated to revision #:**

- a. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Configuration Guide to v2.27*

Please refer to each collateral for details.

**4. The following collaterals have been updated to revision #:**

- a. *Intel® HNS2600KP Compute Module / H2000G Chassis Power and Thermal Budget Configuration Tool to v1.5*

Please refer to each collateral for details.

**5. The following collaterals have been updated to revision #:**

- a. *Intel® Server Board S2600KP and Intel® Compute Module HNS2600KP Product Family Technical Product Specification to v1.37*

Please refer to each collateral for details.

## 6. Specification Changes

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### 1. Microsoft\* Windows\* Server 2016 added to the compatible list of Operating Systems.

The Intel® Server Board S2600KP Product Family has passed the certification for Microsoft\* Windows\* Server 2016 Operating System. Please refer to the Operating System Compatibility webpage <http://www.intel.com/content/www/us/en/support/boards-and-kits/000007713.html>.

### 2. System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Package version is R0018.

- a. BIOS release has been updated to version 01.01.0018
- b. ME release has been updated to version 03.01.03.032
- c. BMC release has been updated to version 01.46.9995

Please refer to the download webpages:

- a. Via EFI-Shell Console: <https://downloadcenter.intel.com/download/26199/>
- b. Via Intel® OFU Tool: <https://downloadcenter.intel.com/download/26200/>

### 3. System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Package version is R0019.

- a. BIOS release has been updated to version 01.01.0019
- b. ME release has been updated to version 03.01.03.032
- c. BMC release has been updated to version 01.47.10181

Please refer to the download webpages:

- a. Via EFI-Shell Console: <https://downloadcenter.intel.com/download/26367/>
- b. Via Intel® OFU Tool: <https://downloadcenter.intel.com/download/26384/>

### 4. System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Package version is R0020.

- a. BIOS release has been updated to version 01.01.0020
- b. ME release has been updated to version 03.01.03.043
- c. BMC release has been updated to version 01.48.10351

Please refer to the download webpages:

- a. Via EFI-Shell Console: <https://downloadcenter.intel.com/download/26516/>
- b. Via Intel® OFU Tool: <https://downloadcenter.intel.com/download/26532/>

### 5. Intel® HNS2600KP Compute Module / H2000G Chassis Power and Thermal Budget Configuration Tool has been released. Tool version is v1.5.

Power calculation formula on “Compute Module 1” has been updated.

Please refer to the download webpages:

- a. Excel spreadsheet: <https://downloadcenter.intel.com/download/24526/>

### 6. System Update Package (SUP) and System Firmware Update Package (SFUP) have been released. Package version is R0021.

- a. BIOS release has been updated to version 01.01.0021
- b. ME release has been updated to version 03.01.03.043
- c. BMC release has been updated to version 01.49.10574

Please refer to the download webpages:

- a. Via EFI-Shell Console: <https://downloadcenter.intel.com/download/26689/>
- b. Via Intel® OFU Tool: <https://downloadcenter.intel.com/download/26723/>